

Electronic Patent Application Fee Transmittal

Application Number:	10588927
Filing Date:	03-Aug-2007
Title of Invention:	Semiconductor Package with Perforated Substrate
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Attorney Docket Number:	1431.168.101/FIN 581 PCT/

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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				810